

	Type	L #	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r s	E r r o r s
1	BRS	L1	19	wafer adj etch\$3 adj bath	USPAT; EPO; JPO	2000/01/12 09:29		0	
2	BRS	L2	23	wafer adj etch\$3 adj bath	USPAT; EPO; JPO	2000/01/12 09:44		0	
3	BRS	L3	0	etach\$3 adj fluid	USPAT; EPO; JPO	2000/01/12 09:45		0	
4	BRS	L4	420	etch\$3 adj fluid	USPAT; EPO; JPO	2000/01/12 09:46		0	
5	BRS	L5	1628	etch\$3 adj bath	USPAT; EPO; JPO	2000/01/12 09:47		0	
6	BRS	L6	160	5 and drain\$3	USPAT; EPO; JPO	2000/01/12 09:47		0	
7	BRS	L7	58	6 and wafer	USPAT; EPO; JPO	2000/01/12 09:47		0	
8	BRS	L8	160	6 and bath	USPAT; EPO; JPO	2000/01/12 09:48		0	
9	BRS	L10	30	6 and valve	USPAT; EPO; JPO	2000/01/12 09:48		0	

	Type	L #	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r s	E r r o r s
10	BRS	L11	95	6 and drain\$3 and top	USPAT; EPO; JPO	2000/01/12 09:50		0	
11	BRS	L12	24	11 and 10	USPAT; EPO; JPO	2000/01/12 09:50		0	
12	BRS	L15	3	13 and hf	USPAT; EPO; JPO	2000/01/12 09:50		0	
13	BRS	L16	10	12 and 7	USPAT; EPO; JPO	2000/01/12 09:57		0	
14	BRS	L17	7	8 and 9	USPAT; EPO; JPO	2000/01/12 10:03		0	
15	BRS	L19	24	10 and 11	USPAT; EPO; JPO	2000/01/12 10:04		0	
16	BRS	L20	6	9 and 8 and 24	USPAT; EPO; JPO	2000/01/12 10:35		0	
17	BRS	L21	158	4 and clean\$3	USPAT; EPO; JPO	2000/01/12 10:36		0	
18	BRS	L22	52	21 and bath	USPAT; EPO; JPO	2000/01/12 10:36		0	

	Type	L #	Hits	Search Text	DBs	Time Stamp	C o m m e n t s	E r r o r s
19	BRS	L23	29	22 and (hingley adj\$10 rleas\$3 adj\$10 door)	USPAT; EPO; JPO	2000/01/12 10:38	n	0
20	BRS	L24	7	6 and door	USPAT; EPO; JPO	2000/01/12 10:45		0